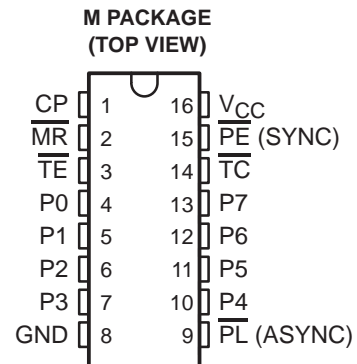


CD74HC40103-Q1
HIGH-SPEED CMOS LOGIC
8-STAGE SYNCHRONOUS DOWN COUNTER
SCLS547 – OCTOBER 2003

- Qualification in Accordance With AEC-Q100†
 - Qualified for Automotive Applications
 - Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
 - Synchronous or Asynchronous Preset
 - Cascadable in Synchronous or Ripple Mode
 - Fanout (Over Temperature Range)
 - Standard Outputs . . . 10 LSTTL Loads
 - Bus Driver Outputs . . . 15 LSTTL Loads
 - Balanced Propagation Delay and Transition Times
 - Significant Power Reduction Compared to LSTTL Logic ICs
- V_{CC} Voltage = 2 V to 6 V
 - High Noise Immunity N_{IL} or N_{IH} = 30% of V_{CC} , $V_{CC} = 5$ V



† Contact factory for details. Q100 qualification data available on request.

description/ordering information

The CD74HC40103 is manufactured with high-speed silicon-gate technology and consists of an 8-stage synchronous down counter with a single output, which is active when the internal count is zero. The device contains a single 8-bit binary counter. Each device has control inputs for enabling or disabling the clock, for clearing the counter to its maximum count, and for presetting the counter either synchronously or asynchronously. All control inputs and the terminal count (\overline{TC}) output are active-low logic.

In normal operation, the counter is decremented by one count on each positive transition of the clock (CP) output. Counting is inhibited when the terminal enable (\overline{TE}) input is high. \overline{TC} goes low when the count reaches zero, if \overline{TE} is low, and remains low for one full clock period.

When the synchronous preset enable (\overline{PE}) input is low, data at the P0–P7 inputs are clocked into the counter on the next positive clock transition, regardless of the state of \overline{TE} . When the asynchronous preset enable (\overline{PL}) input is low, data at the P0–P7 inputs asynchronously are forced into the counter, regardless of the state of the \overline{PE} , \overline{TE} , or CP inputs. Inputs P0–P7 represent a single 8-bit binary word for the CD74HC40103. When the master reset (\overline{MR}) input is low, the counter asynchronously is cleared to its maximum count of 255₁₀, regardless of the state of any other input. The precedence relationship between control inputs is indicated in the truth table.

If all control inputs except \overline{TE} are high at the time of zero count, the counters jump to the maximum count, giving a counting sequence of 100₁₆ or 256₁₀ clock pulses long.

ORDERING INFORMATION

T_A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	SOIC – M	Tape and reel	CD74HC40103QM96Q1	HC40103Q

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated

CD74HC40103-Q1

HIGH-SPEED CMOS LOGIC

8-STAGE SYNCHRONOUS DOWN COUNTER

SCLS547 – OCTOBER 2003

description/ordering information (continued)

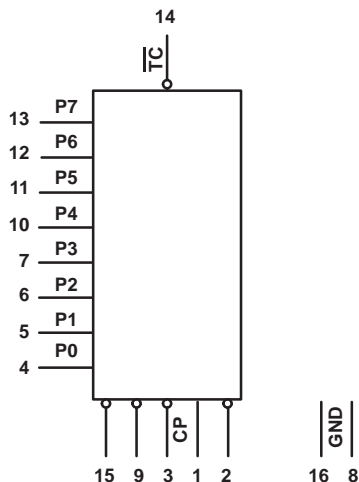
The CD74HC40103 may be cascaded using the \overline{TE} input and the \overline{TC} output, in either synchronous or ripple mode. These circuits have the low power consumption usually associated with CMOS circuitry, yet have speeds comparable to low-power Schottky TTL circuits and can drive up to ten LSTTL loads.

FUNCTION TABLE

CONTROL INPUTS				PRESET MODE	ACTION
\overline{MR}	\overline{PL}	\overline{PE}	\overline{TE}		
H	H	H	H	Synchronous	Inhibit counter
H	H	H	L		Count down
H	H	L	X		Preset on next positive clock transition
H	L	X	X	Asynchronous	Preset asynchronously
L	X	X	X		Clear to maximum count

NOTE: H = high voltage level, L = low voltage level, X = don't care
 Clock connected to clock input
 Synchronous operation: changes occur on negative-to-positive clock transitions.
 Load inputs: MSB = P7, LSB = P0

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1)	-0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V)	± 20 mA
Output clamp current, I_{OK} ($V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V)	± 20 mA
Source or sink current per output pin, I_O ($V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V)	± 25 mA
Continuous current through V_{CC} or GND	± 50 mA
Package thermal impedance, θ_{JA} (see Note 2)	73°C/W
Maximum junction temperature, T_J	150°C
Lead temperature (during soldering):	
At distance 1/16 ± 1/32 inch (1,59 ± 0,79 mm) from case for 10 s max	300°C
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages referenced to GND unless otherwise specified.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT	
V_{CC}	Supply voltage	2	6	V	
V_{IH}	High-level input voltage	$V_{CC} = 2$ V	1.5	V	
		$V_{CC} = 4.5$ V	3.15		
		$V_{CC} = 6$ V	4.2		
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V	0.5	V	
		$V_{CC} = 4.5$ V	1.35		
		$V_{CC} = 6$ V	1.8		
V_I	Input voltage	0	V_{CC}	V	
V_O	Output voltage	0	V_{CC}	V	
t_t	Input transition (rise and fall) time	$V_{CC} = 2$ V	0	1000	ns
		$V_{CC} = 4.5$ V	0	500	
		$V_{CC} = 6$ V	0	400	
T_A	Operating free-air temperature	-40	125	°C	

NOTES: 3. All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

CD74HC40103-Q1
HIGH-SPEED CMOS LOGIC
8-STAGE SYNCHRONOUS DOWN COUNTER

SCLS547 – OCTOBER 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		I _O (mA)	V _{CC}	T _A = 25°C		MIN	MAX	UNIT
					MIN	MAX			
V _{OH}	V _I = V _{IH} or V _{IL}	CMOS loads	-0.02	2 V	1.9		1.9	V	
			-0.02	4.5 V	4.4		4.4		
			-0.02	6 V	5.9		5.9		
		TTL loads	-4	4.5 V	3.98		3.7		
			-5.2	6 V	5.48		5.2		
V _{OL}	V _I = V _{IH} or V _{IL}	CMOS loads	0.02	2 V		0.1		0.1	V
			0.02	4.5 V		0.1		0.1	
			0.02	6 V		0.1		0.1	
		TTL loads	4	4.5 V		0.26		0.4	
			5.2	6 V		0.26		0.4	
I _I	V _I = V _{CC} or GND		6 V		±0.1		±1	μA	
I _{CC}	V _I = V _{CC} or GND		6 V	0		8		160	μA
C _{IN}	C _L = 50 pF					10		10	pF



CD74HC40103-Q1
HIGH-SPEED CMOS LOGIC
8-STAGE SYNCHRONOUS DOWN COUNTER
 SCLS547 – OCTOBER 2003

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER		V _{CC}	T _A = 25°C		MIN	MAX	UNIT
			MIN	MAX			
t _w	Pulse duration	CP	2 V	165	250	ns	
			4.5 V	33	50		
			6 V	28	43		
	$\overline{\text{PL}}$	2 V	125	190			
		4.5 V	25	38			
		6 V	21	32			
	$\overline{\text{MR}}$	2 V	125	190			
		4.5 V	25	38			
		6 V	21	32			
f _{max}	CP frequency (see Note 4)	2 V	3	2	MHz		
		4.5 V	15	10			
		6 V	18	12			
t _{su}	P to CP	2 V	100	150	ns		
		4.5 V	20	30			
		6 V	17	26			
	$\overline{\text{PE}}$ to CP	2 V	75	110			
		4.5 V	15	22			
		6 V	13	19			
	$\overline{\text{TE}}$ to CP	2 V	150	225			
		4.5 V	30	45			
		6 V	26	38			
	To CP, $\overline{\text{MR}}$ inactive	2 V	50	75			
		4.5 V	10	15			
		6 V	9	13			
t _h	P to CP	2 V	5	5	ns		
		4.5 V	5	5			
		6 V	5	5			
	$\overline{\text{TE}}$ to CP	2 V	0	0			
		4.5 V	0	0			
		6 V	0	0			
	$\overline{\text{PE}}$ to CP	2 V	2	2			
		4.5 V	2	2			
		6 V	2	2			

NOTE 4: Noncascaded operation only. With cascaded counters, clock-to-terminal count propagation delays, count enables ($\overline{\text{PE}}$ or $\overline{\text{TE}}$) to clock setup times, and count enables ($\overline{\text{PE}}$ or $\overline{\text{TE}}$) to clock hold times determine maximum clock frequency. For example, with these HC devices:

$$\text{CP } f_{\text{max}} = \frac{1}{\text{CP to TC prop delay} + \overline{\text{TE}} \text{ to CP setup time} + \overline{\text{TE}} \text{ to CP hold time}} = \frac{1}{60 + 30 + 0} \approx 11 \text{ MHz}$$



CD74HC40103-Q1
HIGH-SPEED CMOS LOGIC
8-STAGE SYNCHRONOUS DOWN COUNTER

SCLS547 – OCTOBER 2003

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	V _{CC}	T _A = 25°C			MIN	MAX	UNIT	
					MIN	TYP	MAX				
t _{pd}	CP	\overline{TC} (asynchronous preset)	C _L = 50 pF	2 V		300		450	ns		
				4.5 V		60	90				
				6 V		51	77				
			C _L = 15 pF	5 V	25						
				\overline{TC} (synchronous preset)	C _L = 50 pF	2 V		300			450
						4.5 V		60		90	
		6 V				51	77				
		C _L = 15 pF	5 V		25						
			\overline{TE}		C _L = 50 pF	2 V		200			300
						4.5 V		40		60	
		6 V				34	51				
		C _L = 15 pF		5 V	17						
	\overline{PL}			C _L = 50 pF	2 V		275			415	
					4.5 V		55	83			
		6 V			47	71					
		C _L = 15 pF	5 V	23							
			\overline{MR}	C _L = 50 pF	2 V		275			415	
					4.5 V		55	83			
	6 V				47	71					
	C _L = 15 pF	5 V		23							
		C _L = 50 pF		2 V		75		110			
				4.5 V		15	22				
	6 V			13	19						
	t _t			C _L = 50 pF	2 V		75			110	ns
			C _L = 50 pF	4.5 V		15		22			
			C _L = 50 pF	6 V		13		19			
f _{max}	CP		C _L = 15 pF	5 V	25				MHz		

operating characteristics, V_{CC} = 5 V, T_A = 25°C, input t_r, t_f = 6 ns

PARAMETER	TYP	UNIT
C _{pd} Power dissipation capacitance (see Note 5)	25	pF

NOTE 5: C_{pd} is used to determine the dynamic power consumption per package.

$$P_D = (C_{pd} \times V_{CC}^2 \times f_i) + (C_L \times V_{CC}^2 \times f_O)$$

f_i = input frequency

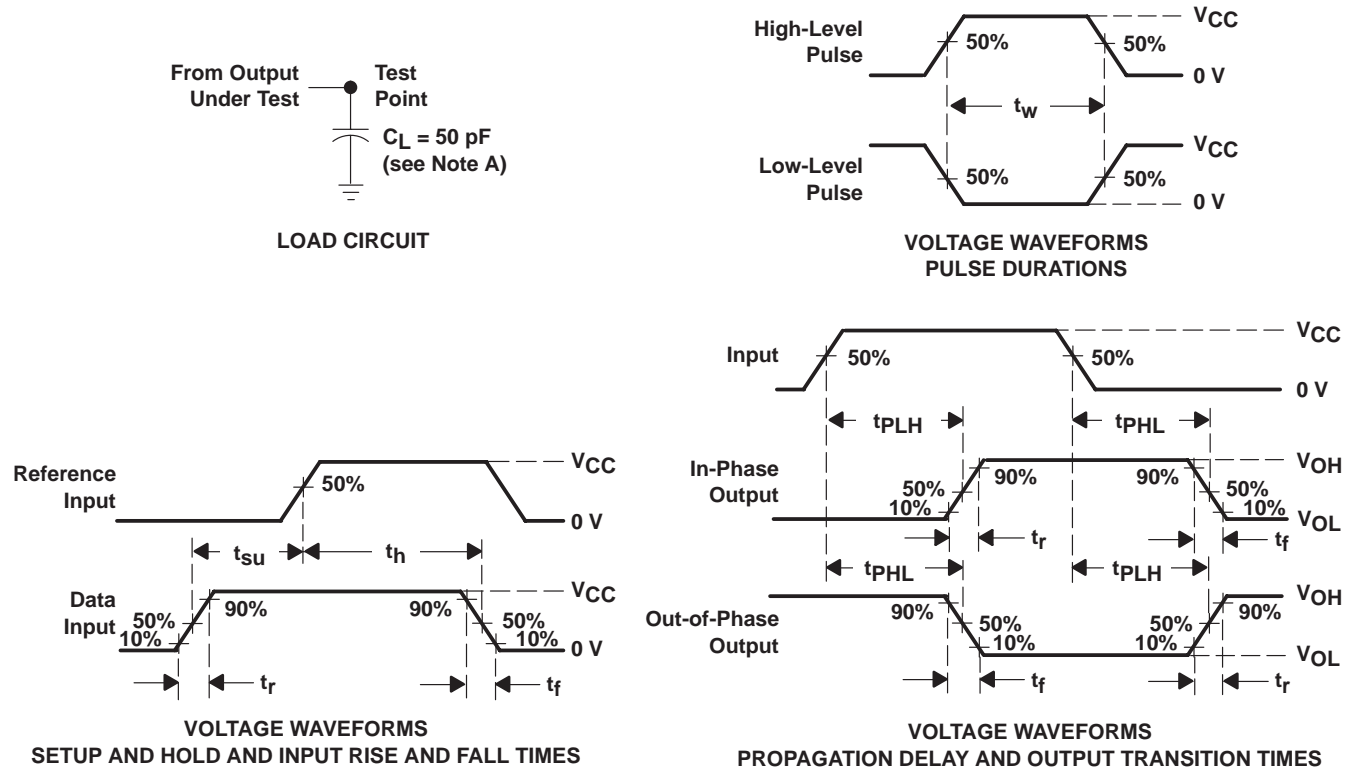
f_O = output frequency

C_L = output load capacitance

V_{CC} = supply voltage



PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50 \Omega$, $t_r = 6$ ns, $t_f = 6$ ns.
 - C. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

CD74HC40103-Q1
HIGH-SPEED CMOS LOGIC
8-STAGE SYNCHRONOUS DOWN COUNTER
 SCLS547 – OCTOBER 2003

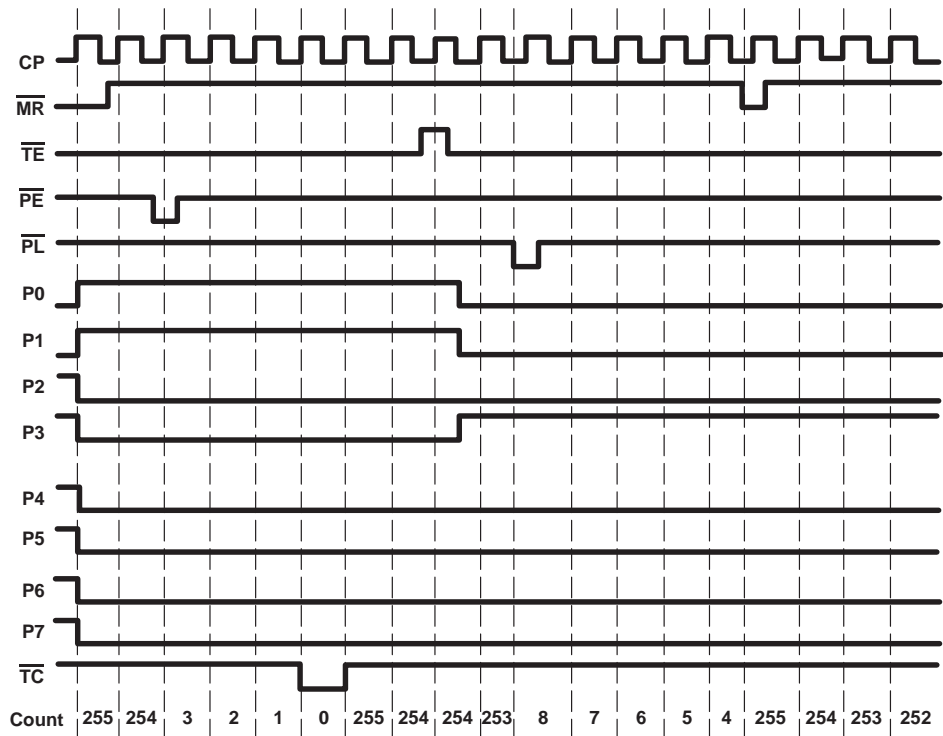
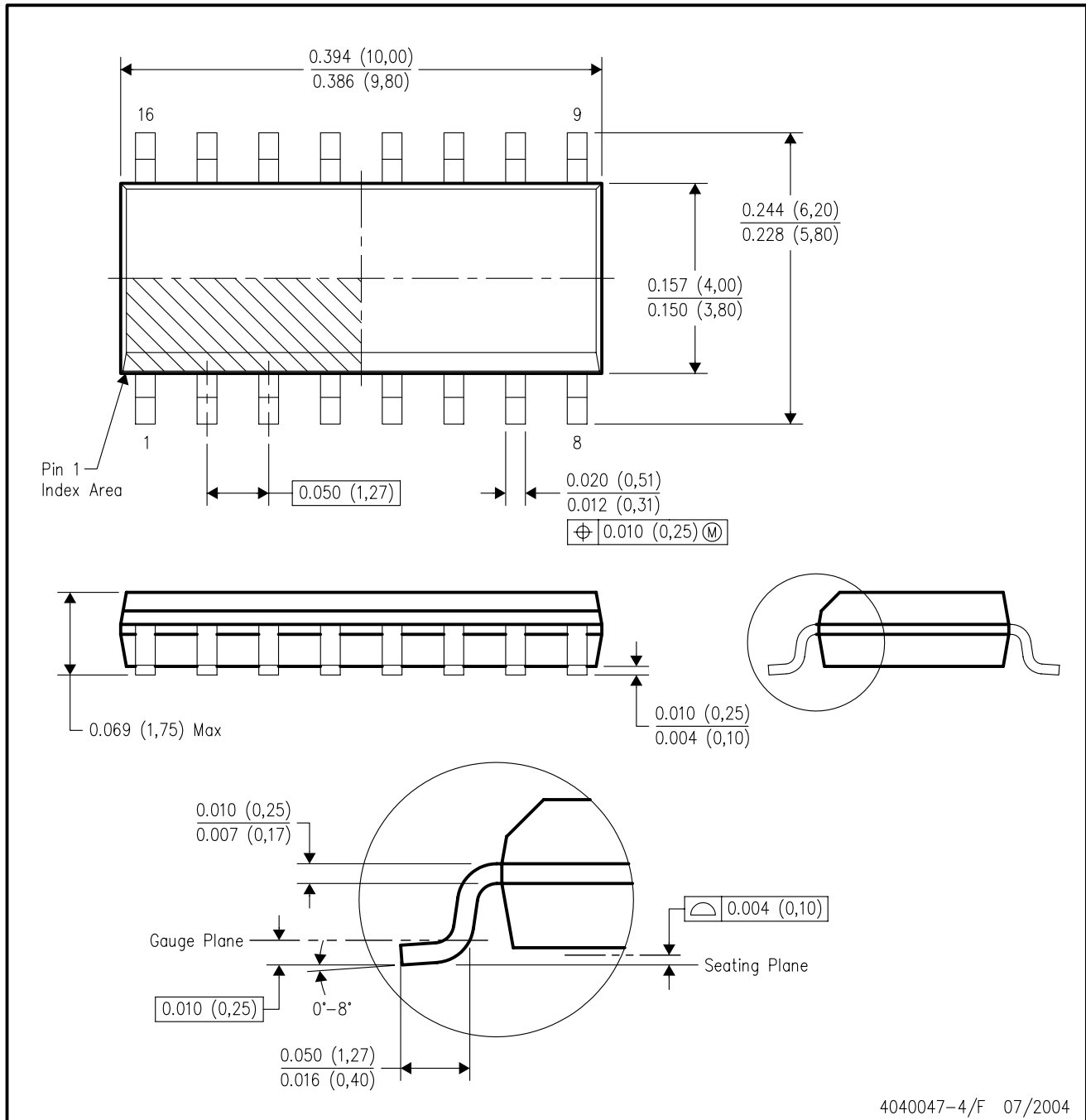


Figure 2. Timing Diagram

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-012 variation AC.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265